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## Patent claims

1. An organic electronic component comprising a patterned functional layer having a thickness of less than 100 nm, the patterning arising by virtue of a lower functional layer being only partially wetted with the organic functional material of the next functional layer.
2. The organic electronic component as claimed in claim 1, in which the patterned functional layer is a semiconducting functional layer.
3. A method for producing an organic electronic component, in which, through targeted treatment of a lower functional layer, an upper functional layer is produced in patterned fashion despite large-area application.
4. The method as claimed in claim 3, in which a semiconducting functional layer is produced in patterned fashion.
5. The method as claimed in claim 4, in which the lower functional layer is partially covered by a resist that can be applied with a very small layer thickness by printing.

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